GAP-151R-S8

1U Rugged Edge Server- Rear I/O & Rear Power supply Dual Socket 5th/4th Gen Intel[®] Xeon[®] Scalable Processors



GAP is a product family of Rugged aluminium Servers and Workstations designed for Edge applications that require a robust MIL-GRADE certified computing platform, suitable for operations in critical environments.

1U	510 MM	2	4TB	UP TO 9	2
PLATFORM	DEPTH	CPU	RAM	HOT SWAP SSD	I/O BOARDS

GAP-151R-S8 Rugged Edge Servers are powered by dual-socket 5th Gen Intel[®] Xeon[®] / 4th Gen Intel[®] Xeon[®] Scalable Processors renowned for their robust architecture with enhanced AI acceleration and advanced security capabilities. Offering improved performance and efficiency, these servers are tailored to meet the demanding requirements of modern computing environments at the Edge. The integrated IPMI services support monitoring,

control, and management functions, sending alarm notifications in case of critical events.

GAP-151R-S8 are designed for 19" rackmounting and have a 1U chassis with a total overall depth of 540mm. Notably, the 19" front brackets of the chassis are strategically positioned in a backward orientation, reducing the required cabinet space to just 510mm once fully installed.

The rear I/O and rear power supply configuration offers versatile storage options, including two on board M.2 NVME SSD and either up to three removable 2.5" SAS SSD, six removable U.2 NVMe SSD or up to nine removable 2.5" SATA SSDs.

Moreover, this rugged server can accommodate up to two full-height half lenght PCIe x16 cards.

For enhanced protection against shocks and vibrations, additional boards can be supplied with a dedicated retainer kit, ensuring optimal safety even during transport.

Built to meet MIL-STD-810F standards for temperature and shock resistance, as well as MIL-STD-167-1A standards for vibration tolerance, GAP Rugged Edge Servers ensure reliable operation under the challenging conditions often found at the Edge. Additionally, they can optionally be configured to comply with MIL-STD-461 standards for EMI/EMC, featuring MIL-grade connectors for either the power input or both the I/O connectors and power supply inputs.

All units are shipped with an inventory list to guarantee configuration control and reproducibility over time. Additionally, upon request, all server configurations can undergo specific thermal or mechanical environmental stress tests.



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Technical Specifications



System

CPU	5 th Gen Intel [®] Xeon [®] / 4 th Gen Intel [®] Xeon [®] Scalable processors, Dual Socket LGA- 4677 (Socket E) supported, CPU TDP Up to 205W TDP	
Memory	Up to 4TB ECC RDIMM, DDR5-4800MT/s in 16 DIMM slots	
Chipset	Intel [®] C741	
Graphics	1 Aspeed AST2600 BMC port	
Network Connectivity	1 x Dedicated IPMI LAN port 2 x AIOM slots supporting 100GbE / 25GbE / 2.5GbE / GbE ports OCP 3.0 NICs	
Storage	Internal: 2 x NVMe M.2, M-Key, 2280 Removable: Up to 3x 2.5" SAS SSD or Up to 6x U.2 NVMe SSD or Up to 9x 2.5" SATA SSD	
ТРМ	1x TPM Header	
Motherboard I/O shield	1 x VGA, 2 x USB 3.0, 1 x IPMI; 1 x COM (available on the rear panel)	
Expansion slots	2x PCle 5.0 x16 FHHL	
Operative Systems	Windows® 11 IoT Enterprise, Windows® 10 IoT Enterprise LTSC, Windows® Server 2022, Windows® Server 2019, Linux	
IPMI	IPMI2.0, SPM, Watchdog; SNMP and e-mail alarms and notifications	
Remote Monitoring	Monitoring, control and management functions (fan speed, temperature, voltage, redundant power failure, power consumption, disk health, RAID health, and memory health)	
Power Supp	ly	
Power Supply	AC or DC Redundant Power Supply - Optional AC Single	

Mechanical

Dimensions	483 x 44 x 510 mm 540 mm full depth (W x H x D)
Material	Aluminum with surface passivation treatment
Colour	Black / RAL 9005 - Powder Coating
Mounting	1U 19" rackmount chassis Optional Telescopic slides
Configuration	Rear I/O - Rear Power Supply
Front Panel Leds / Buttons / Connectors	Power On/Off button with LED Reset button with LED 2x USB 3.0
Fans	6x internal PWM fans

Environmental - (Design to meet)

Operating Temperatures	0°C to +50°C MIL-STD-810H, Method 501.7 & 502.7 -20°C to +60°C (depending on configuration)		
Storage Temperature	-40°C to +70°C MIL-STD-810H, Method 501.7 & 502.7		
Humidity	5% – 95% non-condensing MIL-STD-810H 507.6		
Operating Vibrations	MIL-STD-167-1A, Type I		
Not Operating Vibrations	1.17 Grms, 5-500 Hz MIL-STD-810H, Method 514.8		
Operating Shocks	20g / 11ms – half sine MIL-STD-810G, Method 516.7		
EMC	Directive 2014/35/UE-LVD Directive 2014/30/UE-EMC Directive 2011/65/ UE - RoHS Regulation EC No 1907/2006 MIL-STD- 461G (on request)		

GAP servers and workstations are designed in accordance with the environmental specifications indicated. Some parameters depend on the configuration. Equipment may be subjected to dedicated test profiles.